

### Complementary 20-V (D-S) MOSFET

#### CHARACTERISTICS

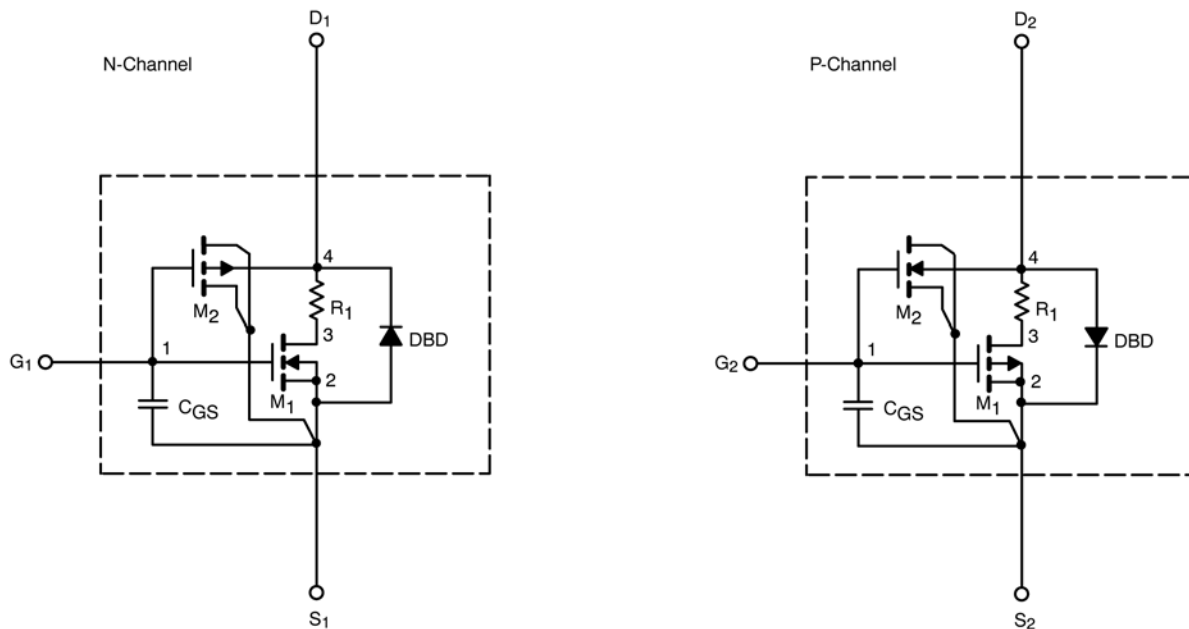
- N- and P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

#### DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n- and p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125°C temperature ranges under the pulsed 0-V to 5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

#### SUBCIRCUIT MODEL SCHEMATIC



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition		Simulated Data	Measured Data	Unit
<b>Static</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	N-Ch	1.1		V
		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	P-Ch	1.1		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 5 V, V <sub>GS</sub> = 4.5 V	N-Ch	1.1		A
		V <sub>DS</sub> ≤ -5 V, V <sub>GS</sub> = -4.5 V	P-Ch	3.1		
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.29 A	N-Ch	1.64	1.55	Ω
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -0.41 A	P-Ch	0.85	0.85	
		V <sub>GS</sub> = 2.7 V, I <sub>D</sub> = 0.1 A	N-Ch	2.34	2.8	
		V <sub>GS</sub> = -2.7 V, I <sub>D</sub> = -0.25 A	P-Ch	1.2	1.23	
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 0.1 A	N-Ch	2.6	3	
		V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -0.25 A	P-Ch	1.33	1.4	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.29 A	N-Ch	0.33	0.30	S
		V <sub>DS</sub> = -10 V, I <sub>D</sub> = -0.41 A	P-Ch	0.80	0.80	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 0.23 A, V <sub>GS</sub> = 0 V	N-Ch	0.67	0.80	V
		I <sub>S</sub> = -0.23 A, V <sub>GS</sub> = 0 V	P-Ch	-0.76	-0.80	
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	Q <sub>g</sub>	N-Channel V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.29 A P-Channel V <sub>DS</sub> = -10 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -0.41 A	N-Ch	0.55	0.72	nC
Gate-Source Charge	Q <sub>gs</sub>		P-Ch	0.52	0.52	
			N-Ch	0.22	0.22	
Gate-Drain Charge	Q <sub>gd</sub>		P-Ch	0.11	0.11	
			N-Ch	0.13	0.13	
Turn-On Delay Time	t <sub>d(on)</sub>		P-Ch	0.14	0.14	
		N-Ch	18	23	ns	
Rise Time	t <sub>r</sub>	P-Ch	8.8	7.5		
		N-Ch	21	30		
Turn-Off Delay Time	t <sub>d(off)</sub>	P-Ch	11	20		
		N-Ch	21	10		
Fall Time	t <sub>f</sub>	P-Ch	11	8.5		
		N-Ch	22	15		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>S</sub> = 0.23 A, di/dt = 100 A/μs	N-Ch	20		20
		I <sub>S</sub> = -0.23 A, di/dt = 100 A/μs	P-Ch	25		25

**Notes**

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2.
- b. Guaranteed by design, not subject to production testing.

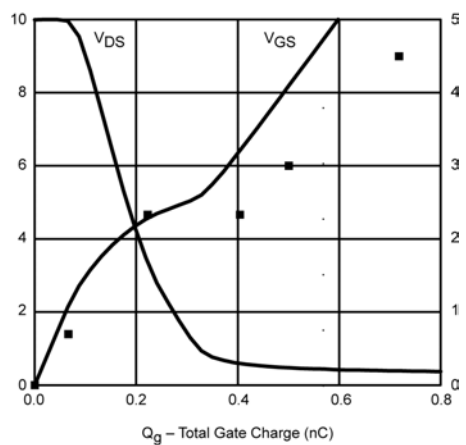
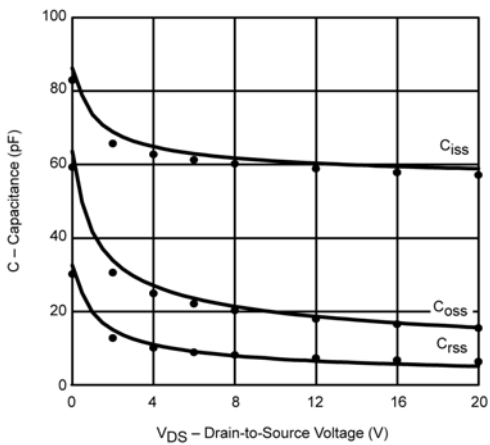
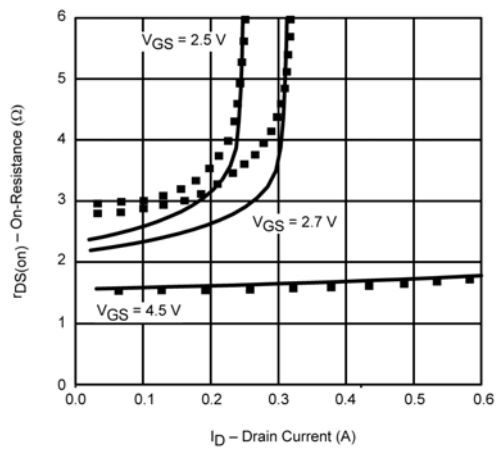
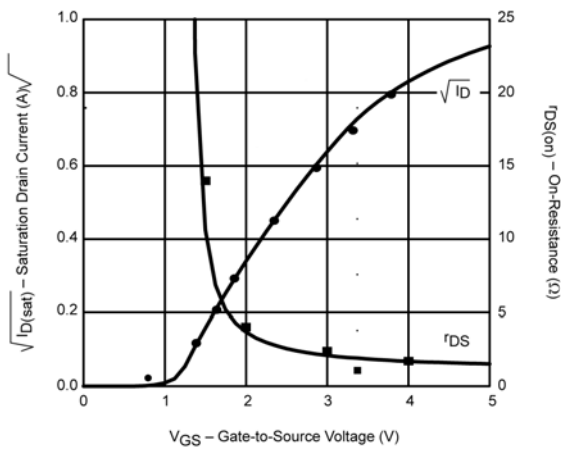
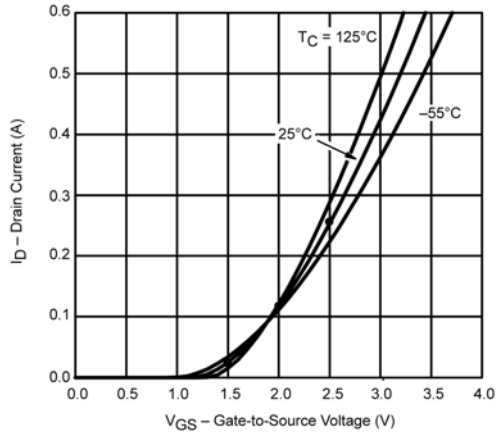
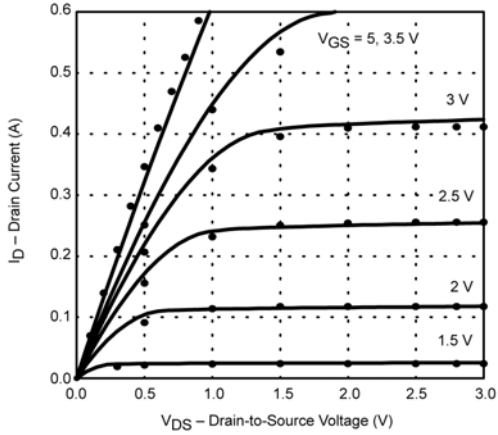


# SPICE Device Model Si1551DL

## Vishay Siliconix

COMPARISON OF MODEL WITH MEASURED DATA ( $T_J=25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

### N-Channel MOSFET



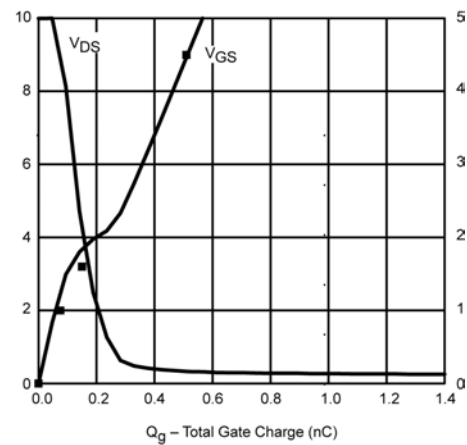
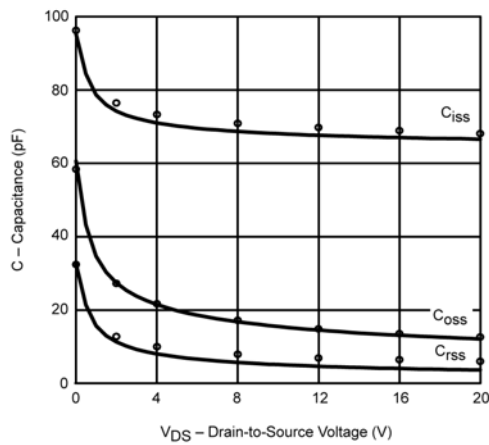
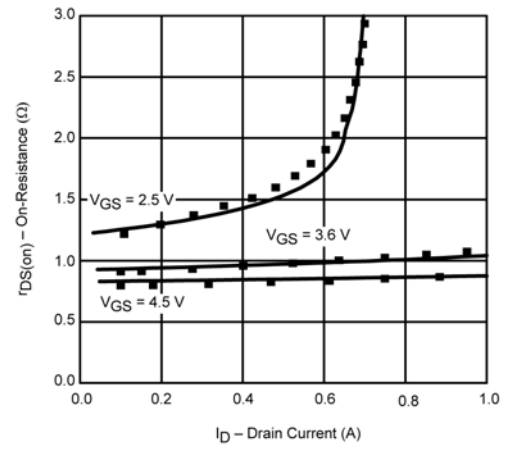
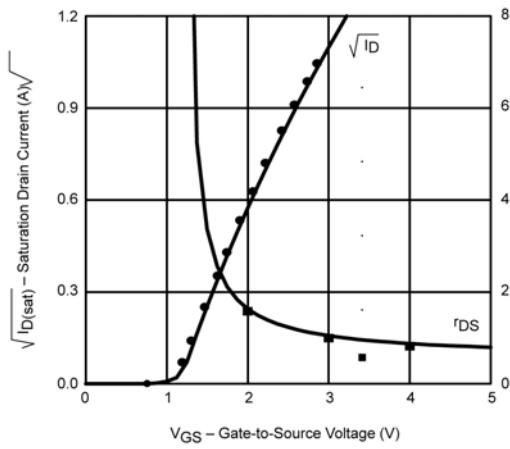
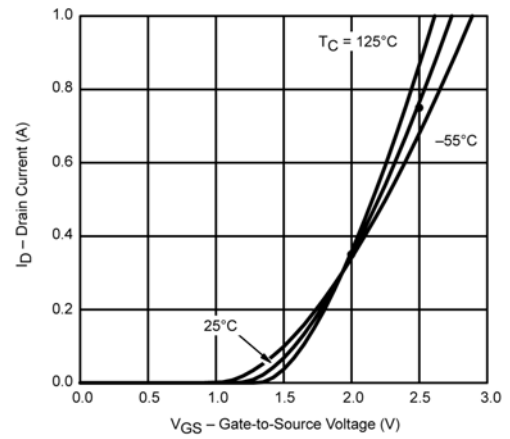
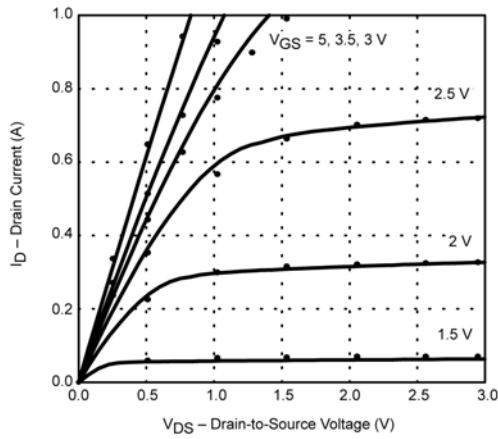
Note: Dots and squares represent measured data.

# SPICE Device Model Si1551DL



## Vishay Siliconix

### P-Channel MOSFET



Note: Dots and squares represent measured data.



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